

9097250 TOSHIBA (DISCRETE/OPTO)

99D 16731 DT-39-13



# SEMICONDUCTOR

## TECHNICAL DATA

TOSHIBA FIELD EFFECT TRANSISTOR  
2 S K 6 4 4  
SILICON N CHANNEL MOS TYPE  
( $\pi$ -MOS1)

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS.  
CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR  
DRIVE APPLICATIONS.

### FEATURES:

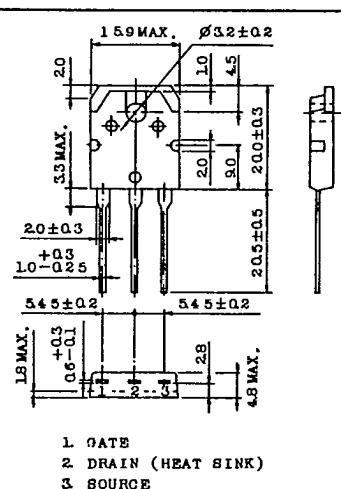
- Low Drain-Source ON Resistance :  $R_{DS(ON)}=0.7\Omega$  (Typ.)
- High Forward Transfer Admittance :  $|Y_{fs}|=6.0S$  (Typ.)
- Low Leakage Current :  $I_{GSS}=\pm 100nA$ (Max.) @  $V_{GS}=\pm 20V$   
 $I_{DSS}=250\mu A$  (Max.) @  $V_{DS}=500V$
- Enhancement-Mode :  $V_{th}=2.0\sim 4.0V$  @  $V_{DS}=10V, I_D=1mA$

### MAXIMUM RATINGS ( $T_a=25^\circ C$ )

| CHARACTERISTIC                               |       | SYMBOL    | RATING        | UNIT       |
|----------------------------------------------|-------|-----------|---------------|------------|
| Drain-Source Voltage                         |       | $V_{DSX}$ | 500           | V          |
| Drain-Gate Voltage ( $R_{GS}=20k\Omega$ )    |       | $V_{DGR}$ | 500           | V          |
| Gate-Source Voltage                          |       | $V_{GSS}$ | $\pm 20$      | V          |
| Drain Current                                | DC    | $I_D$     | 10            | A          |
|                                              | Pulse | $I_{DP}$  | 30            |            |
| Drain Power Dissipation ( $T_c=25^\circ C$ ) |       | $P_D$     | 125           | W          |
| Channel Temperature                          |       | $T_{ch}$  | 150           | $^\circ C$ |
| Storage Temperature Range                    |       | $T_{stg}$ | $-55\sim 150$ | $^\circ C$ |

### INDUSTRIAL APPLICATIONS

Unit in mm



JEDEC

EIAJ

TOSHIBA

2-16C1B

Weight : 4.6g

### THERMAL CHARACTERISTICS

| CHARACTERISTIC                                                                   | SYMBOL        | MAX. | UNIT         |
|----------------------------------------------------------------------------------|---------------|------|--------------|
| Thermal Resistance, Junction to Case                                             | $R_{th(j-c)}$ | 1.0  | $^\circ C/W$ |
| Thermal Resistance, Junction to Ambient                                          | $R_{th(j-a)}$ | 50   | $^\circ C/W$ |
| Maximum Lead Temperature for Soldering Purposes (1.6mm from case for 10 seconds) | $T_L$         | 300  | $^\circ C$   |

TOSHIBA CORPORATION

GT1A3A

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## TECHNICAL DATA

2 S K 6 4 4

## ELECTRICAL CHARACTERISTICS (Ta=25°C)

| CHARACTERISTIC                                  | SYMBOL        | TEST CONDITION                         | MIN. | TYP. | MAX.      | UNIT     |
|-------------------------------------------------|---------------|----------------------------------------|------|------|-----------|----------|
| Gate Leakage Current                            | $I_{GSS}$     | $V_{GS}=\pm 20V, V_{DS}=0V$            | -    | -    | $\pm 100$ | nA       |
| Drain Cut-off Current                           | $I_{DSS}$     | $V_{DS}=500V, V_{GS}=0V$               | -    | -    | 300       | $\mu A$  |
| Drain-Source Breakdown Voltage                  | $V_{(BR)DSS}$ | $I_D=10mA, V_{GS}=0V$                  | 500  | -    | -         | V        |
| Gate Threshold Voltage                          | $V_{th}$      | $V_{DS}=10V, I_D=1mA$                  | 2.0  | -    | 4.0       | V        |
| Forward Transfer Admittance                     | $ Y_{fs} $    | $V_{DS}=10V, I_D=5A$                   | 3.0  | 6.0  | -         | S        |
| Drain-Source ON Resistance                      | $R_{DS(ON)}$  | $I_D=5A, V_{GS}=10V$                   | -    | 0.7  | 1.0       | $\Omega$ |
| Drain-Source ON Voltage                         | $V_{DS(ON)}$  | $I_D=10A, V_{GS}=10V$                  | -    | 8.5  | 12.5      | V        |
| Input Capacitance                               | $C_{iss}$     | $V_{DS}=10V, V_{GS}=0V, f=1MHz$        | -    | 1350 | 1800      | pF       |
| Reverse Transfer Capacitance                    | $C_{rss}$     |                                        | -    | 260  | 450       |          |
| Output Capacitance                              | $C_{oss}$     |                                        | -    | 560  | 750       |          |
| Switching Time                                  | Rise Time     |                                        | -    | 35   | 70        | ns       |
|                                                 | Turn-on Time  |                                        | -    | 50   | 100       |          |
|                                                 | Fall Time     |                                        | -    | 35   | 70        |          |
|                                                 | Turn-off Time |                                        | -    | 200  | 400       |          |
| Total Gate Charge (Gate-Source Plus Gate-Drain) | $Q_g$         | $I_D=10A, V_{GS}=10V$<br>$V_{DD}=400V$ | -    | 47   | 60        | nC       |
| Gate-Source Charge                              | $Q_{gs}$      |                                        | -    | 22   | -         |          |
| Gate-Drain ("Miller") Charge                    | $Q_{gd}$      |                                        | -    | 25   | -         |          |

## SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta=25°C)

| CHARACTERISTIC                   | SYMBOL    | TEST CONDITION          | MIN. | TYP. | MAX. | UNIT    |
|----------------------------------|-----------|-------------------------|------|------|------|---------|
| Continuous Drain Reverse Current | $I_{DR}$  | --                      | -    | -    | 10   | A       |
| Pulse Drain Reverse Current      | $I_{DRP}$ | --                      | -    | -    | 30   | A       |
| Diode Forward Voltage            | $V_{DSF}$ | $I_{DR}=10A, V_{GS}=0V$ | -    | -    | 2.0  | V       |
| Reverse Recovery Time            | $t_{rr}$  | $I_{DR}=10A$            | -    | 350  | -    | ns      |
| Reverse Recovered Charge         | $Q_{rr}$  | $dI_{DR}/dt=100A/\mu s$ | -    | 2.4  | -    | $\mu C$ |

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GT1A3A

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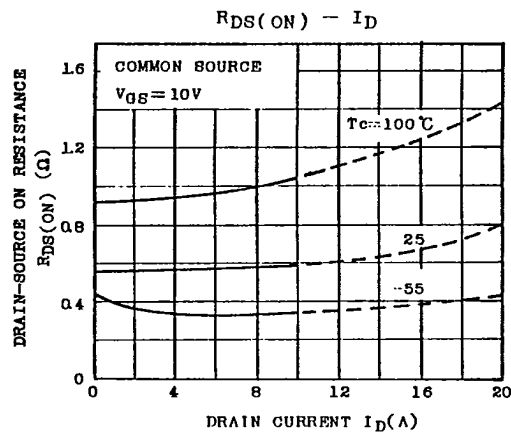
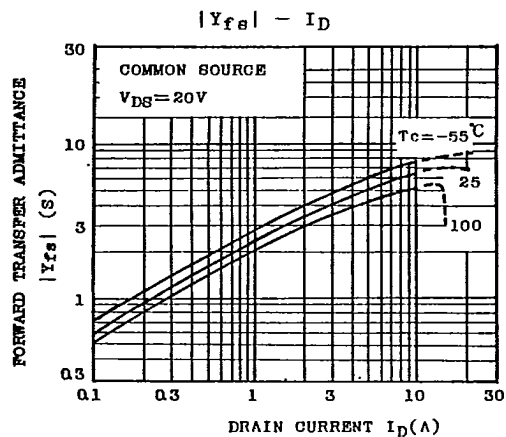
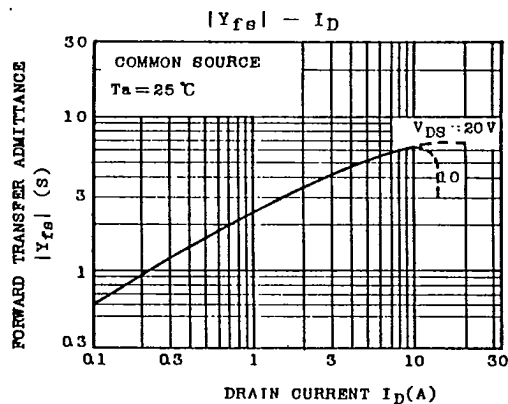
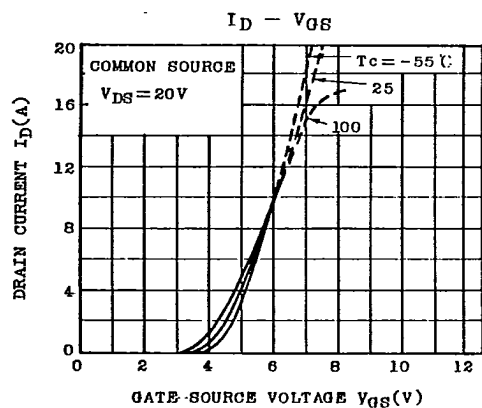
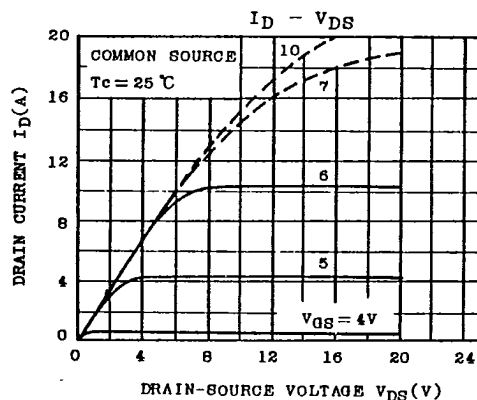
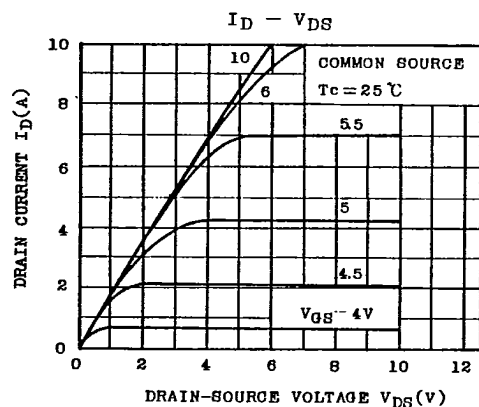
9097250 TOSHIBA (DISCRETE/OPTO)

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# TOSHIBA SEMICONDUCTOR

## TECHNICAL DATA

2SK644



EGA-2SK644-3

TOSHIBA CORPORATION

9097250 TOSHIBA (DISCRETE/OPTO)

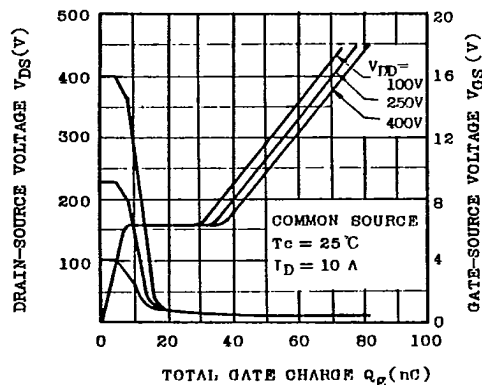
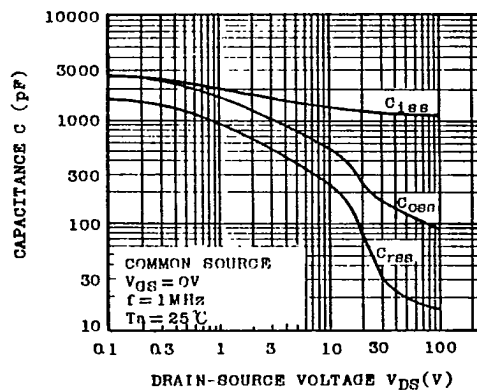
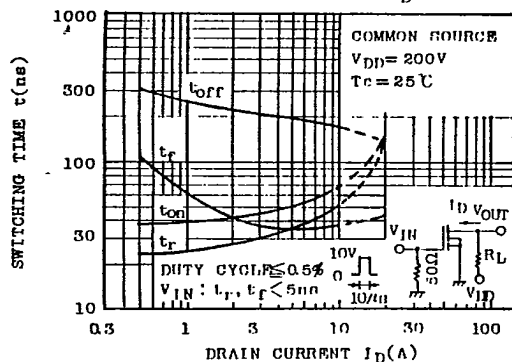
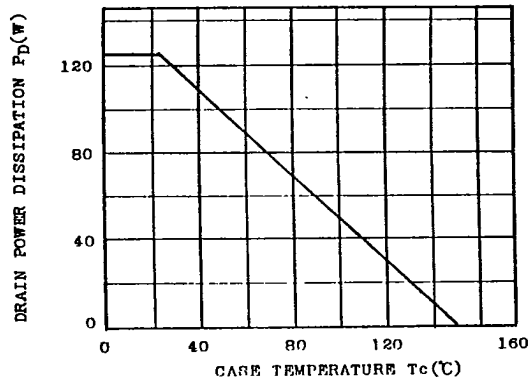
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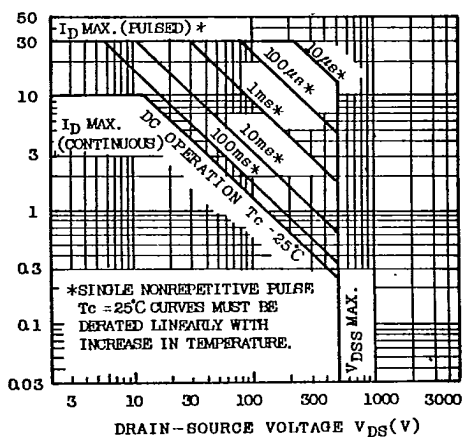
**TOSHIBA****SEMICONDUCTOR**

TECHNICAL DATA

2SK644

DYNAMIC INPUT/OUTPUT  
CHARACTERISTICSCAPACITANCE- $V_{DS}$ SWITCHING TIME- $I_D$  $P_D - T_c$ 

## SAFE OPERATING AREA



EGA-2SK644-4

TOSHIBA CORPORATION